onsemi

With 5 V–Tolerant Inputs and Outputs (3–State, Non–Inverting)

MC74LCX574

The MC74LCX574 is a high performance, non-inverting octal D-type flip-flop operating from a 1.65 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5 V allows MC74LCX574 inputs to be safely driven from 5.0 V devices.

The MC74LCX574 consists of 8 edge-triggered flip-flops with individual D-type inputs and 3-state true outputs. The buffered clock and buffered Output Enable (\overline{OE}) are common to all flip-flops. The eight flip-flops will store the state of individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transition. With the \overline{OE} LOW, the contents of the eight flip-flops are available at the outputs. When the \overline{OE} is HIGH, the outputs go to the high impedance state. The \overline{OE} input level does not affect the operation of the flip-flops. The LCX574 flow through design facilitates easy PC board layout.

Features

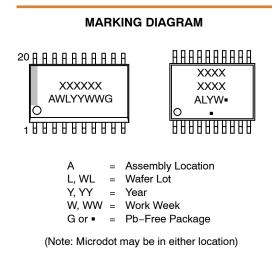
- Designed for 1.65 to 5.5 V V_{CC} Operation
- 5 V Tolerant Interface Capability With 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0$ V
- LVTTL Compatible
- LVCMOS Compatible
- 24mA Balanced Output Sink and Source Capability at 3 V
- Near Zero Static Supply Current in All Three Logic States (10 μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 100 mA
- ESD Performance:
 - ◆ Human Body Model >2000 V
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant





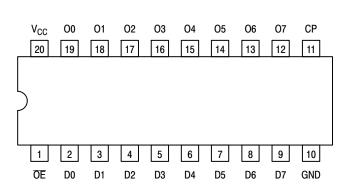


SOIC-20 WB DW SUFFIX CASE 751D-05 TSSOP-20 DT SUFFIX CASE 948E



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.





PIN NAMES

Pins	Function
ŌĒ	Output Enable Input
CP	Clock Pulse Input
D0-D7	Data Inputs
00–07	3-State Outputs

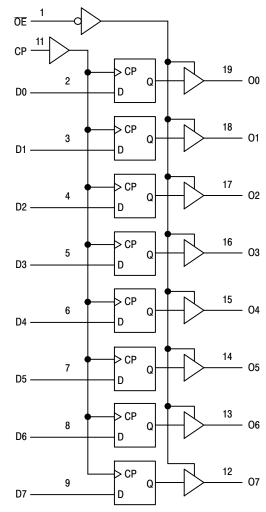


Figure 2. Logic Diagram

TRUTH TABLE

	INPUTS		INTERNAL LATCHES	OUTPUTS	
ŌĒ	СР	Dn	Q	On	OPERATING MODE
L	$\uparrow \uparrow$	l h	L H	L H	Load and Read Register
L	1	Х	NC	NC	Hold and Read Register
Н	1	Х	NC	Z	Hold and Disable Outputs
H H	$\uparrow \uparrow$	l h	L H	Z Z	Load Internal Register and Disable Outputs

Н High Voltage Level =

High Voltage Level One Setup Time Prior to the Low-to-High Clock Transition h =

Low Voltage Level L =

Low Voltage Level One Setup Time Prior to the Low-to-High Clock Transition L =

NC = No Change

Х High or Low Voltage Level and Transitions are Acceptable =

- High Impedance State =
- Z ↑ ↓ Low-to-High Transition =

Not a Low-to-High Transition; For I_{CC} Reasons, DO NOT FLOAT Inputs =

MAXIMUM RATINGS

Symbol	Para	ameter	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
	DC Output Voltage (Note 1)	Active-Mode (High or Low State)	–0.5 to V _{CC} + 0.5	
Vo		Tri-State Mode	-0.5 to +6.5	V
		Power-Down Mode ($V_{CC} = 0 V$)	-0.5 to +6.5	
Ι _{ΙΚ}	DC Input Diode Current	V _{IN} < GND	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Gr	ound Pin	±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for	10 secs	260	°C
TJ	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC-20W	96	°C/W
		TSSOP-20	150	
PD	Power Dissipation in Still Air	SOIC-20W	1302	mW
		TSSOP-20	833	
MSL	Moisture Sensitivity	SOIC-20W	Level 3	-
		All Other Packages	Level 1	
F _R	Flammability Rating Oxygen Index: 28 to	0 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	> 2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Io absolute maximum rating must be observed.
 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	P	arameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri-State Mode Power Down Mode (V _{CC} = 0 V)	0 0 0	- - -	V _{CC} 5.5 5.5	V
T _A	Operating Free-Air Temperature		-55	-	+125	°C
t _r , t _f	Input Rise or Fall Rate	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 1.65 \; V \; to \; 1.95 \; V \\ V_{CC} = 2.3 \; V \; to \; 2.7 \; V \\ V_I \; from \; 0.8 \; V \; to \; 2.0 \; V, \; V_{CC} = 3.0 \; V \\ V_{CC} = 4.5 \; V \; to \; 5.5 \; V \end{array}$	0 0 0 0	- - - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

				T _A = -40 °C	C to +85 °C	T _A = -55 °C	to +125 °C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Min	Мах	Unit
V _{IH}	High-Level Input Voltage		1.65 to 1.95	0.65 x V _{CC}		0.65 x V _{CC}		V
			2.3 to 2.7	1.7		1.7		
			2.7 to 3.6	2.0		2.0		
			4.5 to 5.5	$0.7 \times V_{CC}$		$0.7 \times V_{CC}$		
V _{IL}	Low-Level Input Voltage		1.65 to 1.95		0.35 x V _{CC}		0.35 x V _{CC}	V
			2.3 to 2.7		0.7		0.7	
			2.7 to 3.6		0.8		0.8	
			4.5 to 5.5		$0.3 \times V_{CC}$		0.3 x V _{CC}	
V _{OH}	High-Level	$V_{I} = V_{IH} \text{ or } V_{IL}$						V
	Output Voltage	I _{OH} = -100 μA	1.65 to 5.5	$V_{CC}-0.1$	-	$V_{CC} - 0.1$	-	
		I _{OH} = -4 mA	1.65	1.2	-	1.2	-	
		I _{OH} = -8 mA	2.3	1.8	-	1.8	-	
		I _{OH} = -12 mA	2.7	2.2	_	2.2	-	
		I _{OH} = -16 mA	3.0	2.4	-	2.4	-	
		I _{OH} = -24 mA	3.0	2.2	_	2.2	-	
		I _{OH} = -32 mA	4.5	3.8		3.8		
V _{OL}	Low-Level	$V_{I} = V_{IH} \text{ or } V_{IL}$						V
	Output Voltage	I _{OL} = 100 μA	1.65 to 5.5	_	0.1	-	0.1	
		I _{OL} = 4 mA	1.65	_	0.45	-	0.45	
		I _{OL} = 8 mA	2.3	_	0.6	-	0.6	
		I _{OL} = 12 mA	2.7	_	0.4	-	0.4	
		I _{OL} = 16 mA	3.0	_	0.4	-	0.4	
		I _{OL} = 24 mA	3.0	_	0.55	-	0.55	
		I _{OL} = 32 mA	4.5		0.6		0.6	
ł	Input Leakage Current	V _I = 0 to 5.5 V	3.6	-	±5.0	-	±5.0	μA
I _{OZ}	3-State Output Leakage Current	$V_{I} = V_{IH} \text{ or } V_{IL},$ $V_{O} = 0 \text{ V to 5.5 V}$	3.6	-	±5.0	-	±5.0	μA
I _{OFF}	Power Off Leakage Current	V _I = 5.5 V or V _O = 5.5 V	0	_	10	_	10	μΑ
I _{CC}	Quiescent Supply Current	V _I = 5.5 V or GND	3.6	-	10	-	10	μA
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 to 3.6	-	500	-	500	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. These values of V_I are used to test DC electrical characteristics only.

AC ELECTRICAL CHARACTERISTICS

				T _A = -40 °	°C to +85 °C	T _A = -55 °C	to +125 °C	
Symbol	Parameter	Test Condition	V _{CC} (V)	Min	Max	Min	Max	Uni
f _{MAX}	Propagation Delay	Waveform 1	1.65 to 1.95	90	-	90	-	ns
			2.3 to 2.7	100	-	100	-	
			2.7	150	-	150	-	
			3.0 to 3.6	150	-	150	-	
			4.5 to 5.5	150	-	150	-	
t _{PLH} ,	Propagation Delay,	Waveform 1	1.65 to 1.95	_	15.0	_	15.0	ns
t _{PHL}	CP to On		2.3 to 2.7	_	10.5	_	10.5	
			2.7	_	9.5	-	9.5	
			3.0 to 3.6	_	8.5	-	8.5	
			4.5 to 5.5	_	6.0	-	6.0	
t _{PZH} ,	Output Enable Time	Waveform 2	1.65 to 1.95	_	15.0	_	15.0	ns
t _{PZL}			2.3 to 2.7	_	10.5	-	10.5	
			2.7	_	9.5	-	9.5	
			3.0 to 3.6	_	8.5	_	8.5	
			4.5 to 5.5	_	6.0	_	6.0	
t _{PHZ} ,	Output Enable Time	Waveform 2	1.65 to 1.95	_	10.0	_	10.0	ns
t _{PLZ}			2.3 to 2.7	-	7.8	-	7.8	
			2.7	_	7.0	_	7.0	
			3.0 to 3.6	-	6.5	-	6.5	
			4.5 to 5.5	_	4.5	_	4.5	
t _s	Setup Time,	Waveform 1	1.65 to 1.95	4.0	-	4.0	-	ns
	Dn to CP		2.3 to 2.7	4.0	_	4.0	_	
			2.7	2.5	_	2.5	_	
			3.0 to 3.6	2.5	_	2.5	_	
			4.5 to 5.5	2.5	_	2.5	_	
t _h	Hold Time,	Waveform 1	1.65 to 1.95	2.0	_	2.0	-	ns
	Dn to CP		2.3 to 2.7	2.0	_	2.0	_	
			2.7	1.5	-	1.5	_	
			3.0 to 3.6	1.5	_	1.5	_	
			4.5 to 5.5	1.5	-	1.5	-	
t _W	Pulse Width,	Waveform 3	1.65 to 1.95	4.0	_	4.0	_	ns
	HIGH or Low		2.3 to 2.7	4.0	-	4.0	_	
			2.7	3.3	-	3.3	-	
			3.0 to 3.6	3.3	-	3.3	_	
			4.5 to 5.5	3.3	-	3.3	-	
t _{OSHL} ,	Output to Output		1.65 to 1.95	_	-	_	_	ns
t _{OSLH}	Skew (Note 6)		2.3 to 2.7	-	-	-	_	
			2.7	_	-	-	-	
			3.0 to 3.6	_	1.0	_	1.0	
			4.5 to 5.5	_	_	_	_	

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

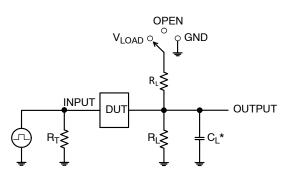
DYNAMIC SWITCHING CHARACTERISTICS

			T,	_A = +25°	С	
Symbol	Characteristic	Condition	Min	Тур	Max	Units
V _{OLP}	Dynamic LOW Peak Voltage (Note 7)	V_{CC} = 3.3 V, C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V		0.8		V
V _{OLV}	Dynamic LOW Valley Voltage (Note 7)	V_{CC} = 3.3 V, C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V		0.8		V

7. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Units
C _{IN}	Input Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	7	pF
C _{OUT}	Output Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	10 MHz, V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	25	pF



Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	V _{LOAD}
t _{PHZ} / t _{PZH}	GND

 C_{L} includes probe and jig capacitance

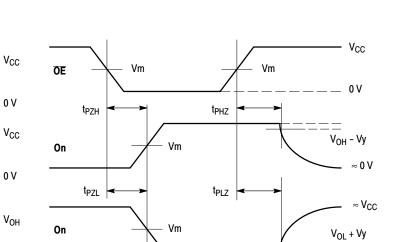
 R_T is Z_{OUT} of pulse generator (typically 50 Ω) f = 1 MHz

ts

Dn

СР

On





- Vm

VOL



th

f_{max}

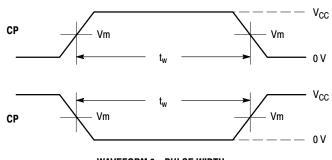
 $t_{\text{PLH}}, t_{\text{PHL}}$

Vm

Vm

WAVEFORM 2 - OUTPUT ENABLE AND DISABLE TIMES t_{R} = t_{F} = 2.5 ns, 10% to 90%; f = 1 MHz; t_{W} = 500 ns

GND



WAVEFORM 3 - PULSE WIDTH $t_{\textrm{R}}$ = $t_{\textrm{F}}$ = 2.5 ns (or fast as required) from 10% to 90%; Output requirements: V_{OL} \leq 0.8 V, V_{OH} \geq 2.0 V

Figure 4. AC Waveforms

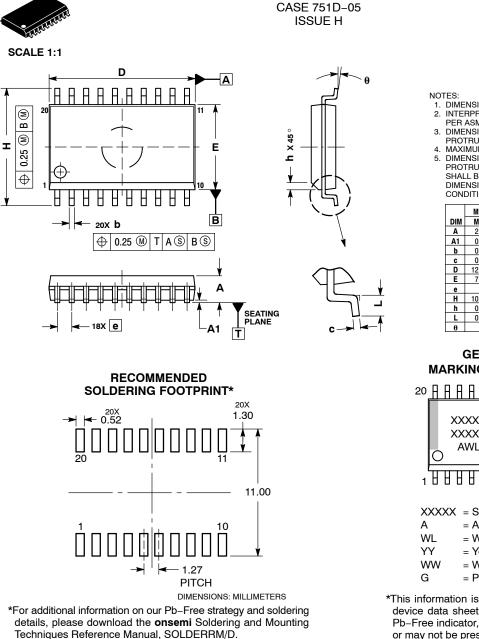
ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MC74LCX574DWR2G	LCX574	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74LCX574DTR2G	LCX 574	TSSOP-20 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D.</u>
 *-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.

semi



SOIC-20 WB

DATE 22 APR 2015

- NOTES:
 DIMENSIONS ARE IN MILLIMETERS.
 INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS
DIM	MIN	MAX
Α	2.35	2.65
A1	0.10	0.25
b	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
е	1.27	BSC
н	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0 °	7 °

GENERIC **MARKING DIAGRAM***

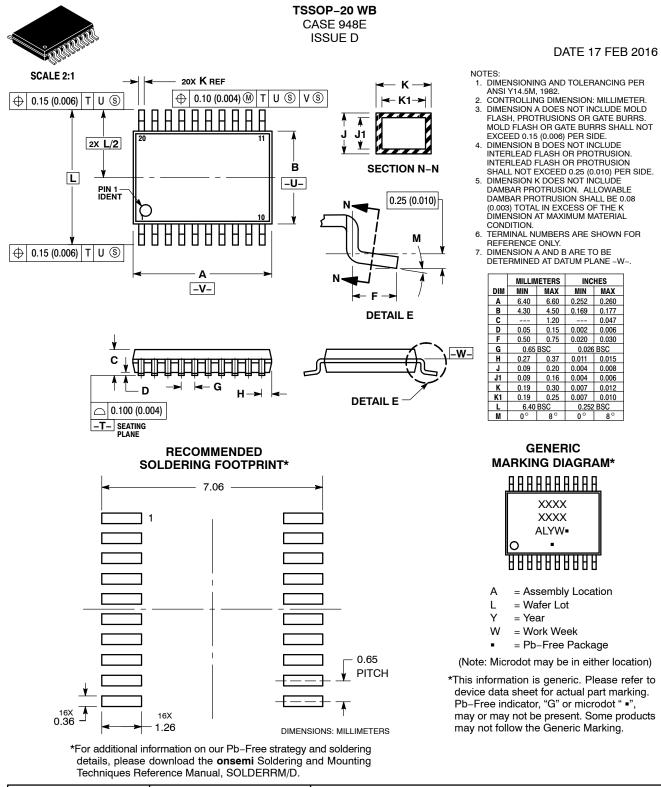
ХХХХХХХХХ ХХХХХХХХХ AWLYYWWG О
XXXXX = Specific Device Code A = Assembly Location WL = Wafer Lot YY = Year WW = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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